09-22-05

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

pplication of:

Donald V. Perino, et al.

Confirmation No.:

4507

Serial No.:

09/961,114

Art Unit:

2833

Filed:

September 20, 2001

Examiner:

Felix Figueroa

For: Chip Socket Assembly and Chip File

Attorney Docket No:

060809-5054-US

Assembly for Semiconductor Chips

PETITION FOR EXTENSION OF TIME UNDER 37 CFR § 1.136(a)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Final Office Action dated March 21, 2005 be extended to a period of three months from June 21, 2005 to and including September 21, 2005.

Applicants are hereby filing this extension of time to establish continuity between this application and a continuing application filed under 37 CFR § 1.53(b) on September 20, 2005 entitled "Chip Socket Assembly and Chip File Assembly for Semiconductor Chips."

The fee for this extension is estimated to be \$ 1,020.00. Please charge the required fee or any additional fee to Morgan, Lewis & Bockius LLP Deposit Account No. 50-0310 (order no. 060809-5054-US). A copy of this sheet is enclosed.

Date:

09/23/2005 MAHMED1 00000046 500310

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September 20, 2005

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Respectfully submitted,

Dion M. Bregman

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